

500 mA LDO with Ripple Blocker Technology

Features

- 1.8V to 3.6V Input Voltage Range
- Active Noise Rejection over a Wide Frequency Band
 - >50 dB from 10 Hz to 5 MHz at 500 mA Load
- Rated to 500 mA Output Current
- Fixed and Adjustable Output Voltages
- Optional Output Auto-Discharge when Disabled
- Current-Limit and Thermal-Limit Protection
- 1.6 mm x 1.6 mm, 6-Lead Ultra Thin DFN
- Logic-Controlled Enable Pin
- -40°C to +125°C Junction Temperature Range

Applications

- Smart Phones
- Tablet PC/Notebooks and Webcams
- Digital Still and Video Cameras
- Global Positioning Systems
- Mobile Computing
- Automotive and Industrial Applications

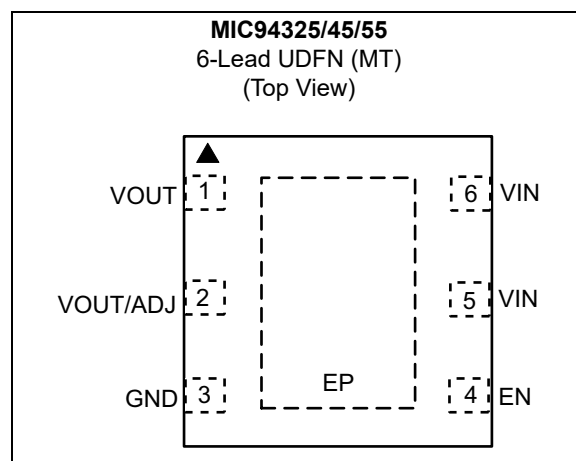
General Description

The MIC94325, MIC94345, and MIC94355 Ripple Blocker™ devices are monolithic integrated circuits that provide low-frequency ripple attenuation (switching noise rejection) to a regulated output voltage. This is important for applications where a DC/DC switching converter is required to lower or raise a battery voltage, but where switching noise cannot be tolerated by sensitive downstream circuits such as in RF applications. The MIC94325/45/55 maintain high power supply ripple rejection (PSRR) with input voltages operating near the output voltage level to improve overall system efficiency. A low-voltage logic enable pin facilitates ON/OFF control at typical GPIO voltage levels.

The MIC94325/45/55 operate from an input voltage of 1.8V to 3.6V. Options include fixed (MIC94345/55) or adjustable (MIC94325) output voltages. The MIC94355 version offers an auto-discharge to discharge the output capacitor when the part is disabled.

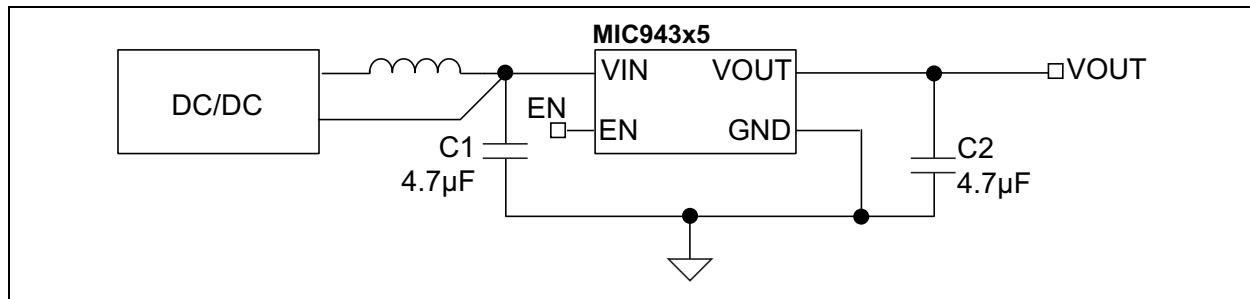
Packaged in a 6-lead 1.6 mm x 1.6 mm Ultra Thin DFN, the MIC94325/45/55 devices have a junction operating temperature range of -40°C to +125°C.

Package Type

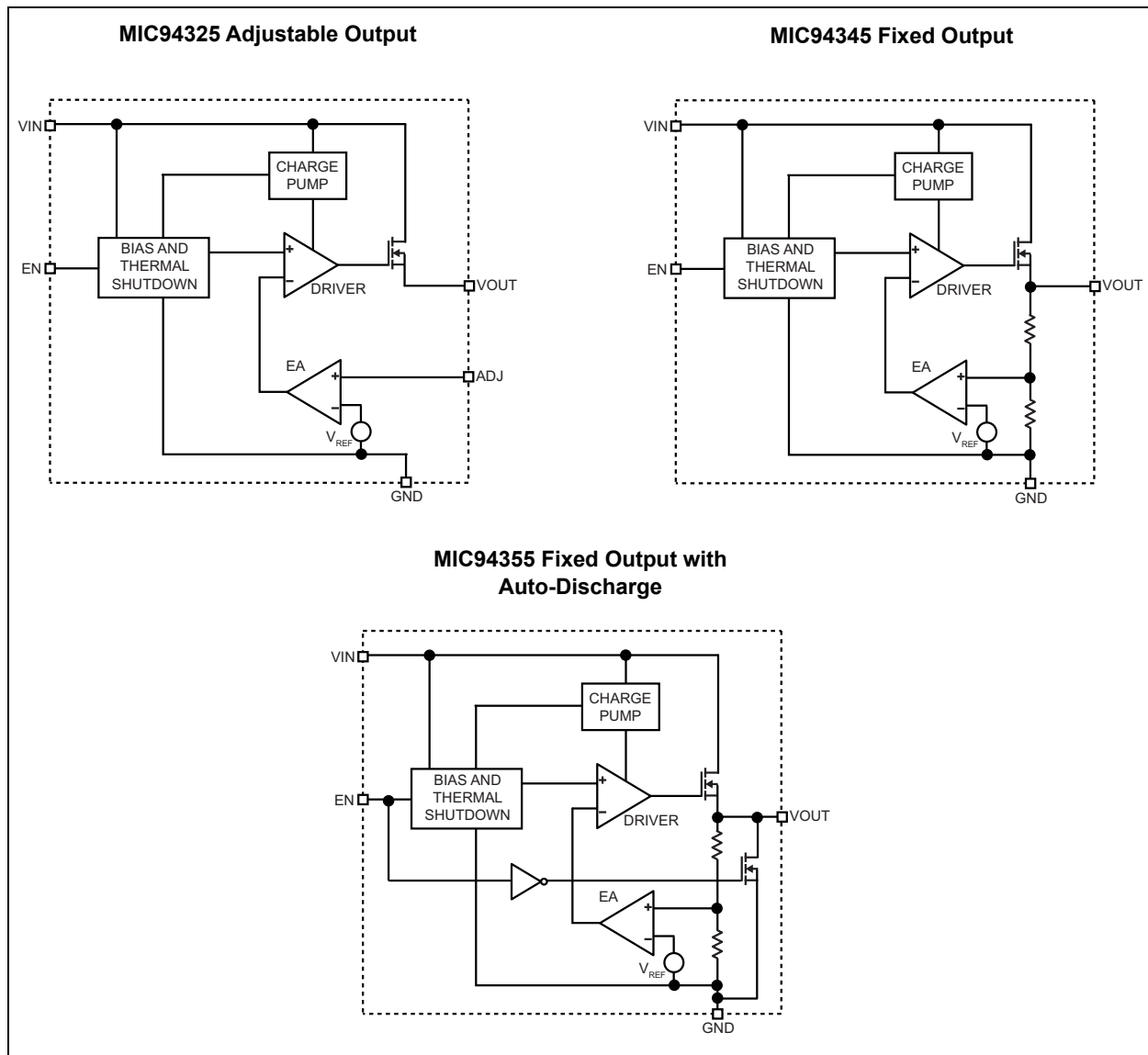


MIC94325/45/55

Typical Application Circuit



Functional Block Diagrams



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Input Voltage (V_{IN})	-0.3V to +4V
Output Voltage (V_{OUT})	-0.3V to $V_{IN} + 0.3V$ or +4V
Enable Voltage (V_{EN})	-0.3V to $V_{IN} + 0.3V$ or +4V
ESD Rating (Note 1)	3 kV

Operating Ratings ††

Input Voltage (V_{IN})	+1.8V to +3.6V
Enable Voltage (V_{EN})	0V to V_{IN}

† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

†† **Notice:** The device is not guaranteed to function outside its operating ratings.

Note 1: Devices are ESD sensitive. Handling precautions recommended. Human body model, 1.5 k Ω in series with 100 pF.

ELECTRICAL CHARACTERISTICS

Electrical Characteristics: $V_{IN} = V_{EN} = V_{OUT} + 500$ mV ($V_{IN} = V_{EN} = 3.6V$ for $V_{OUT} \geq 3.1V$); $I_{OUT} = 1$ mA; $C_{OUT} = 4.7$ μ F; $T_A = +25^\circ\text{C}$, **bold** values are valid for $-40^\circ\text{C} \leq T_J \leq +125^\circ\text{C}$, unless noted. [Note 1](#)

Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions
Input Voltage	V_{IN}	1.8	—	3.6	V	—
Output Voltage Range	V_{OUT}	1.2	—	3.4	V	MIC94325
Output Voltage Accuracy	—	-3	± 1	+3	%	Variation from nominal V_{OUT}
Adjust Reference	V_{ADJ}	—	1.1	—	V	MIC94325
Dropout Voltage	V_{DROP}	—	10	—	mV	V_{IN} to V_{OUT} dropout at 50 mA output current
		—	100	200		V_{IN} to V_{OUT} dropout at 500 mA output current
Load Regulation	ΔV_{OUT}	—	10	—	mV	1 mA to 500 mA
Line Regulation	$\frac{\Delta V_{OUT}}{(V_{OUT} \times \Delta V_{IN})}$	—	0.1	1	%/V	$V_{IN} = V_{OUT} + 500$ mV to 3.6V, $I_{OUT} = 100$ mA
Ground Current	I_{GND}	—	170	250	μ A	$I_{OUT} = 100$ μ A
Shutdown Current	I_{EN}	—	0.2	5	μ A	$V_{EN} = 0V$
V_{IN} Ripple Rejection	PSRR	—	85	—	dB	f = 100 Hz
		—	85	—		f = 1 kHz
		—	57	—		f = 100 kHz
		—	60	—		f = 1 MHz
		—	50	—		f = 5 MHz
Current Limit	I_{LIMIT}	530	800	1100	mA	$V_{OUT} = 0V$
Total Output Noise	e_N	—	83	—	μ V _{RMS}	10 Hz to 100 kHz
Turn-On Time	t_{ON}	—	100	150	μ s	—

Note 1: Specification for packaged product only.

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical Characteristics: $V_{IN} = V_{EN} = V_{OUT} + 500 \text{ mV}$ ($V_{IN} = V_{EN} = 3.6 \text{ V}$ for $V_{OUT} \geq 3.1 \text{ V}$); $I_{OUT} = 1 \text{ mA}$; $C_{OUT} = 4.7 \text{ }\mu\text{F}$; $T_A = +25^\circ\text{C}$, **bold** values are valid for $-40^\circ\text{C} \leq T_J \leq +125^\circ\text{C}$, unless noted. [Note 1](#)

Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions
Auto Discharge NFET Resistance	R_{DS}	—	50	—	Ω	$V_{IN} = 3.6 \text{ V}$, $V_{EN} = 0 \text{ V}$, $I_{OUT} = -3 \text{ mA}$ MIC94355 Only
Enable						
Input Logic Low	V_{EN-LOW}	—	—	0.35	V	—
Input Logic High	$V_{EN-HIGH}$	1.0	—	—	V	—
Input Current	I_{IN}	—	0.01	1	μA	—

Note 1: Specification for packaged product only.

TEMPERATURE SPECIFICATIONS

Parameters	Sym.	Min.	Typ.	Max.	Units	Conditions
Temperature Ranges						
Junction Temperature Range	T_J	-40	—	+125	$^\circ\text{C}$	—
Storage Temperature Range	T_S	-65	—	+150	$^\circ\text{C}$	—
Lead Temperature	—	—	—	+260	$^\circ\text{C}$	Soldering, 10 sec.
Package Thermal Resistances						
Thermal Resistance, UDFN 6-Lead	θ_{JA}	—	92	—	$^\circ\text{C/W}$	—

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A , T_J , θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125 $^\circ\text{C}$ rating. Sustained junction temperatures above +125 $^\circ\text{C}$ can impact the device reliability.

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

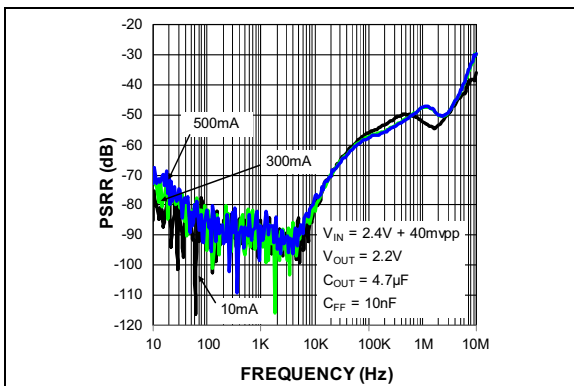


FIGURE 2-1: MIC94325 PSRR,
 $C_{OUT} = 4.7 \mu F$, $C_{FF} = 10 nF$.

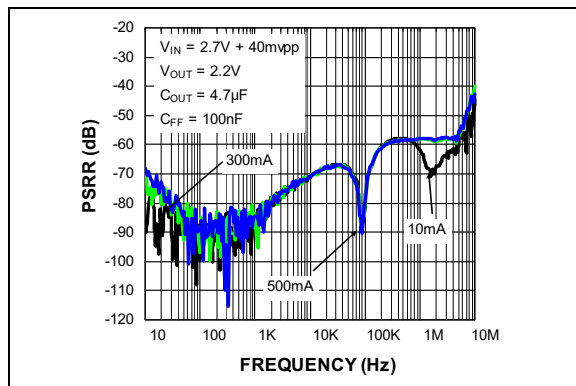


FIGURE 2-4: MIC94325 PSRR,
 $C_{OUT} = 4.7 \mu F$, $C_{FF} = 100 nF$.

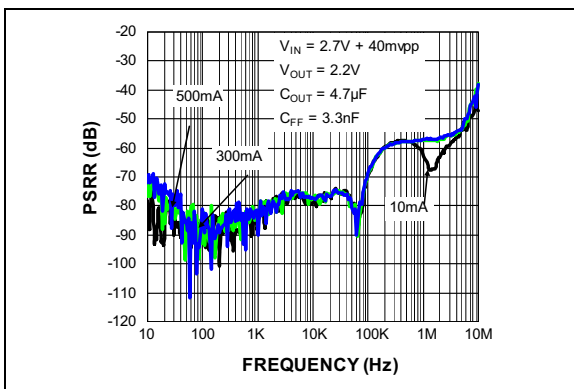


FIGURE 2-2: MIC94325 PSRR,
 $C_{OUT} = 4.7 \mu F$, $C_{FF} = 3.3 nF$.

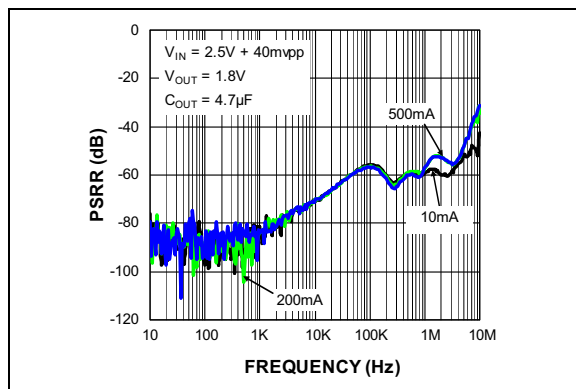


FIGURE 2-5: MIC94355 PSRR,
 $C_{OUT} = 4.7 \mu F$.

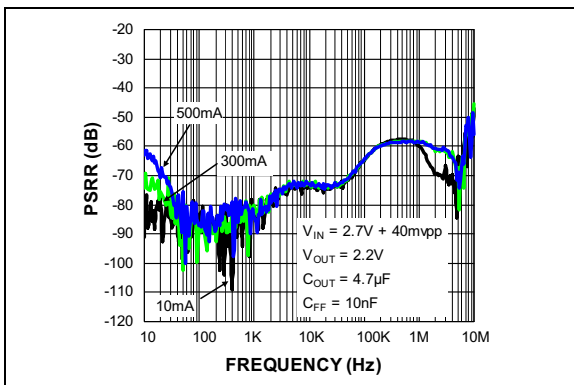


FIGURE 2-3: MIC94325 PSRR,
 $C_{OUT} = 4.7 \mu F$, $C_{FF} = 10 nF$.

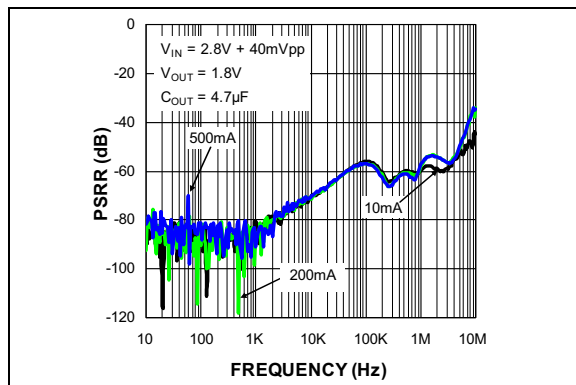


FIGURE 2-6: MIC94355 PSRR,
 $C_{OUT} = 4.7 \mu F$.

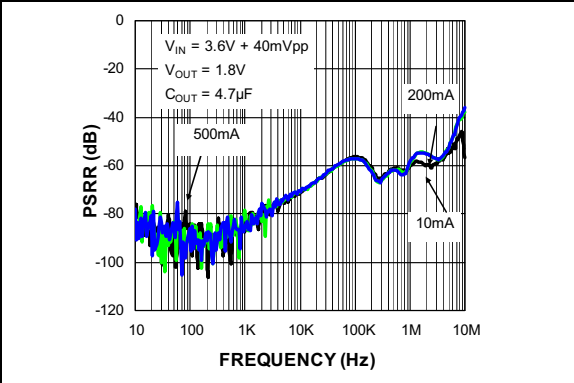


FIGURE 2-7: MIC94355 PSRR, $C_{OUT} = 4.7\mu F$.

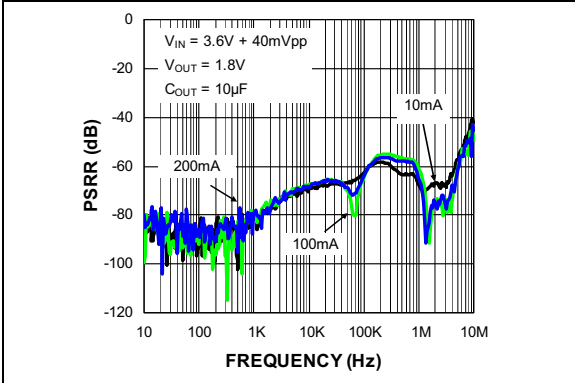


FIGURE 2-10: MIC94355 PSRR, $C_{OUT} = 10\mu F$.

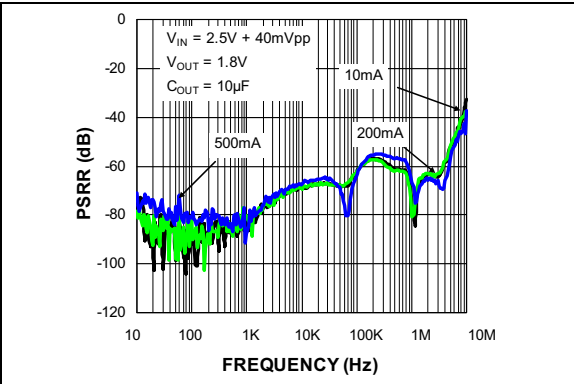


FIGURE 2-8: MIC94355 PSRR, $C_{OUT} = 10\mu F$.

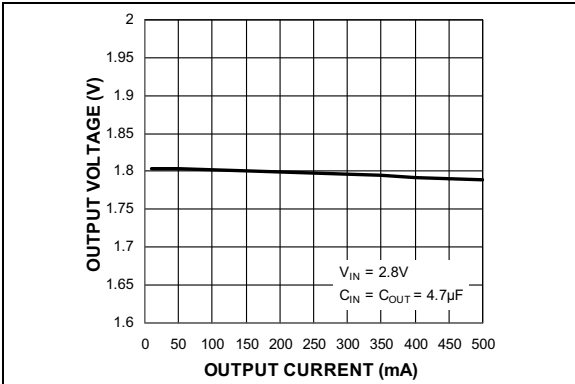


FIGURE 2-11: Output Voltage vs. Output Current.

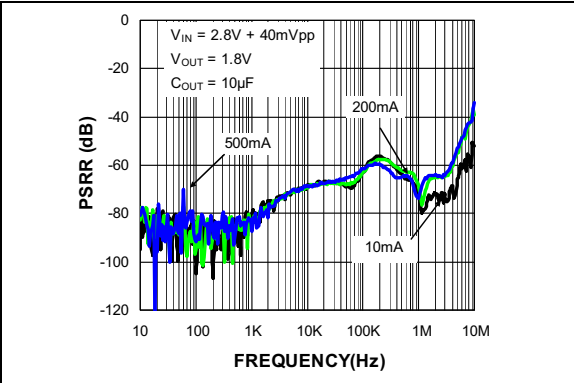


FIGURE 2-9: MIC94355 PSRR, $C_{OUT} = 10\mu F$.

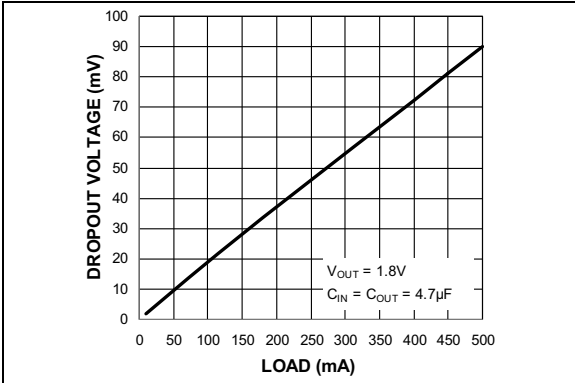


FIGURE 2-12: Dropout Voltage vs. Load.

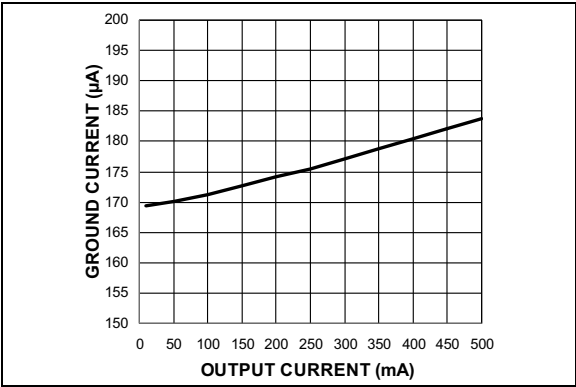


FIGURE 2-13: Ground Current vs. Output Current.

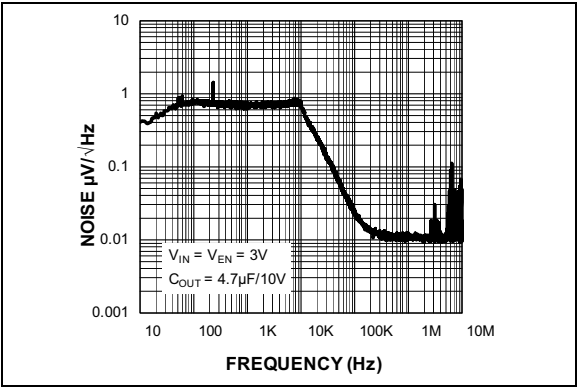


FIGURE 2-15: MIC94355YMT Output Noise Spectral Density.

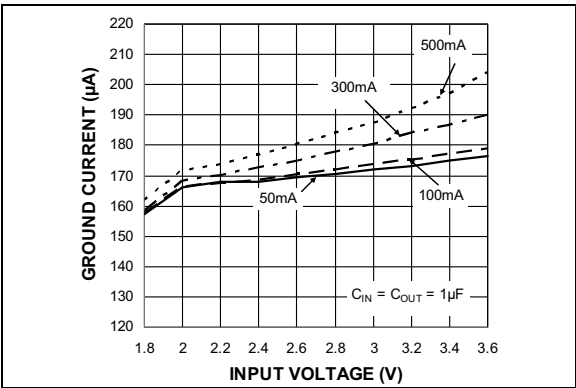


FIGURE 2-14: Ground Current vs. Input Voltage.

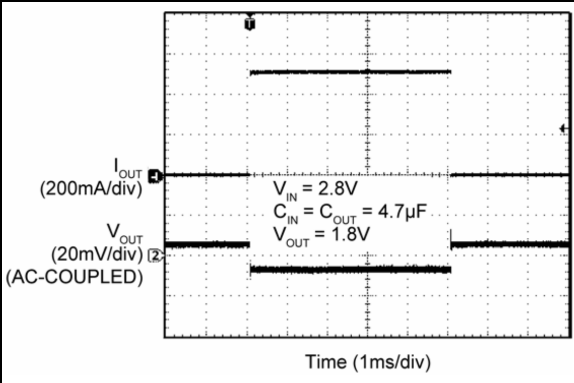


FIGURE 2-16: Load Transient.

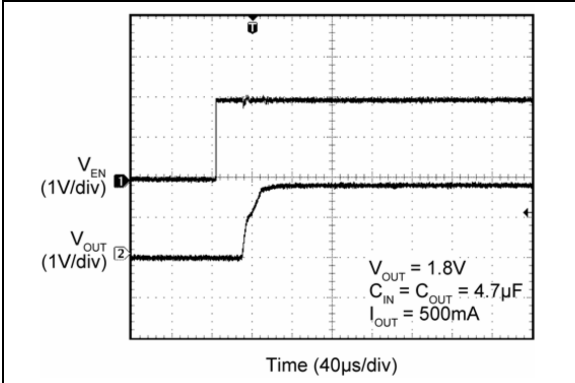


FIGURE 2-18: Turn-On Time.

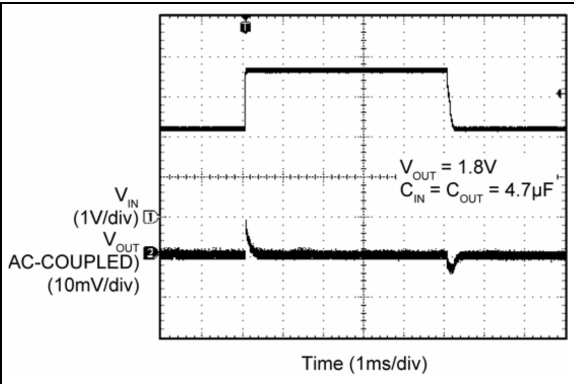


FIGURE 2-17: Line Transient.

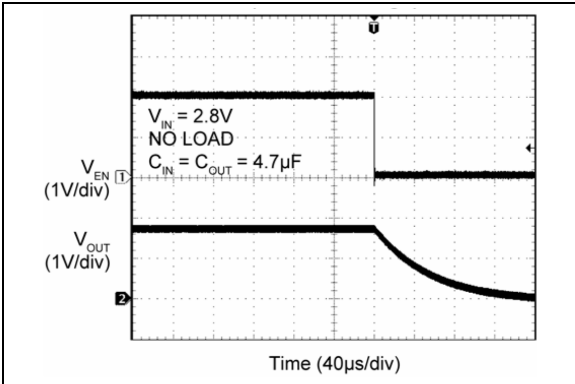


FIGURE 2-19: Turn-Off Time (Auto-Discharge).

3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in [Table 3-1](#).

TABLE 3-1: PIN FUNCTION TABLE

Pin Number UDFN, Fixed	Pin Number UDFN, Adj.	Pin Name	Description
1, 2	1	VOUT	Power Switch Output.
—	2	ADJ	Adjust input. Connect to resistive divider at VOUT to set the output voltage. Do not leave floating.
3	3	GND	Ground.
4	4	EN	Enable Input. A logic HIGH signal on this pin enables the part. Logic LOW disables the part. Do not leave floating.
5, 6	5, 6	VIN	Power Switch Input and Chip Supply.
EP	EP	ePAD	Exposed Heatsink Pad. Connect to Ground plane for best thermal performance.

4.0 APPLICATION INFORMATION

The MIC943x5 family of products are very high PSRR, fixed-output, 500 mA LDOs that use Ripple Blocker™ technology. The MIC943x5 are fully protected from damage due to fault conditions, offering linear current limiting and thermal shutdown.

4.1 Input Capacitor

The MIC943x5 are high-performance, high-bandwidth devices. An input capacitor of 4.7 μF is required from the input to ground to provide stability. Low-ESR ceramic capacitors provide optimal performance at a minimum of space. Additional high-frequency capacitors, such as small-valued NPO dielectric-type capacitors, help filter out high-frequency noise and are good practice in any RF-based circuit. X5R or X7R dielectrics are recommended for the input capacitor. Y5V dielectrics lose most of their capacitance over temperature and are therefore, not recommended.

4.2 Output Capacitor

In order to maintain stability, the MIC943x5 require an output capacitor of 4.7 μF or greater. For optimal input voltage ripple rejection performance a 4.7 μF capacitor is recommended. The design is optimized for use with low-ESR ceramic chip capacitors. High-ESR capacitors are not recommended because they may cause high-frequency oscillation. The output capacitor can be increased, but performance has been optimized for a 4.7 μF ceramic output capacitor and does not improve significantly with larger capacitance.

X7R/X5R dielectric type ceramic capacitors are recommended because of their temperature performance. X7R type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change their value by as much as 50% and 60%, respectively, over their operating temperature ranges. To use a ceramic chip capacitor with the Y5V dielectric, the value must be much higher than an X7R ceramic capacitor to ensure the same minimum capacitance over the equivalent operating temperature range.

4.3 No Load Stability

The MIC943x5 will remain stable and in regulation with no load. This is especially important in CMOS RAM keep-alive applications.

4.4 Enable/Shutdown

Forcing the enable (EN) pin low disables the MIC943x5 and sends it into a “zero” off mode current state. In this state, current consumed by the MIC943x5 goes nearly to zero. Forcing EN high enables the output voltage. The EN pin uses CMOS technology and cannot be left floating as it could cause an indeterminate state on the output.

For the MIC94325 adjustable part, the turn-on time is affected by the selection of the external feedback resistors and feed-forward capacitor. The relationship is approximately $2.2 \times R2 \times C_{FF}$, where R2 is the bottom resistor (connected from ADJ to GND) and C_{FF} is the capacitor connected across R1 (from VOUT to ADJ). For stability, the feed-forward capacitor must be greater than 1 nF. However, 10 nF is recommended for best performance.

When disabled, the MIC94355 switches a 50Ω (typical) load on the regulator output to discharge the external capacitors.

4.5 Adjustable Regulator Application

The MIC94325 output voltage can be adjusted by using two external resistors (Figure 4-1). The resistors set the output voltage based on the following equation:

EQUATION 4-1:

$$V_{OUT} = V_{ADJ} \left(1 + \frac{R1}{R2} \right)$$

$$V_{ADJ} = 1.1V$$

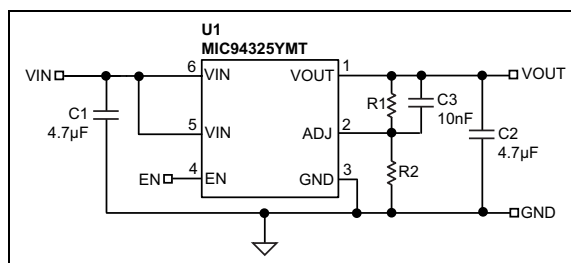


FIGURE 4-1: Adjustable Output Voltage.

4.6 Thermal Considerations

The MIC943x5 are designed to provide 500 mA of continuous current in a very small package. Maximum ambient operating temperature can be calculated based on the output current and the voltage drop across the part. For example, if the input voltage is 2.5V, the output voltage is 1.8V, and the output current is 500 mA. The actual power dissipation of the Ripple Blocker™ can be determined using the equation:

EQUATION 4-2:

$$P_D = (V_{IN} - V_{OUT1}) \times I_{OUT} + V_{IN} \times I_{GND}$$

Because this device is CMOS and the ground current is typically <170 µA over the load range, the power dissipation contributed by the ground current is <1% and can be ignored for this calculation.

EQUATION 4-3:

$$P_D = (2.5V - 1.8V) \times 500mA = 0.35W$$

To determine the maximum ambient operating temperature of the package, use the junction-to-ambient thermal resistance of the device and the following basic equation:

EQUATION 4-4:

$$P_{D(MAX)} = \frac{T_{J(MAX)} - T_A}{\theta_{JA}}$$

Where:

$T_{J(MAX)} = 125^\circ\text{C}$

θ_{JA} = Thermal resistance. 92°C/W for the UDFN package.

Substituting P_D for $P_{D(MAX)}$ and solving for the ambient operating temperature will give the maximum operating conditions for the regulator circuit.

The maximum power dissipation must not be exceeded for proper operation.

For example, when operating the MIC94325-GYMT at an input voltage of 2.5V and 500 mA load with a minimum footprint layout, the maximum ambient operating temperature T_A can be determined as follows:

EQUATION 4-5:

$$0.35W = (125^\circ\text{C} - T_A) / (92^\circ\text{C/W})$$

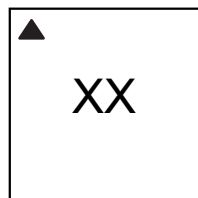
$$T_A = 92^\circ\text{C}$$

Therefore, the maximum ambient operating temperature allowed in a 1.6 mm x 1.6 mm Ultra Thin DFN package is 92°C . For a full discussion of heat sinking and thermal effects on voltage regulators, refer to the “Regulator Thermals” section of Microchip’s [Designing with Low-Dropout Voltage Regulators Handbook](#).

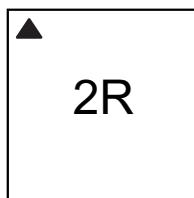
5.0 PACKAGING INFORMATION

5.1 Package Marking Information

6-Lead UDFN*



Example



Legend:	XX...X	Product code or customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC® designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.
	•, ▲, ▼	Pin one index is identified by a dot, delta up, or delta down (triangle mark).
Note:	In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.	
	Underbar (_) and/or Overbar (¯) symbol may not be to scale.	

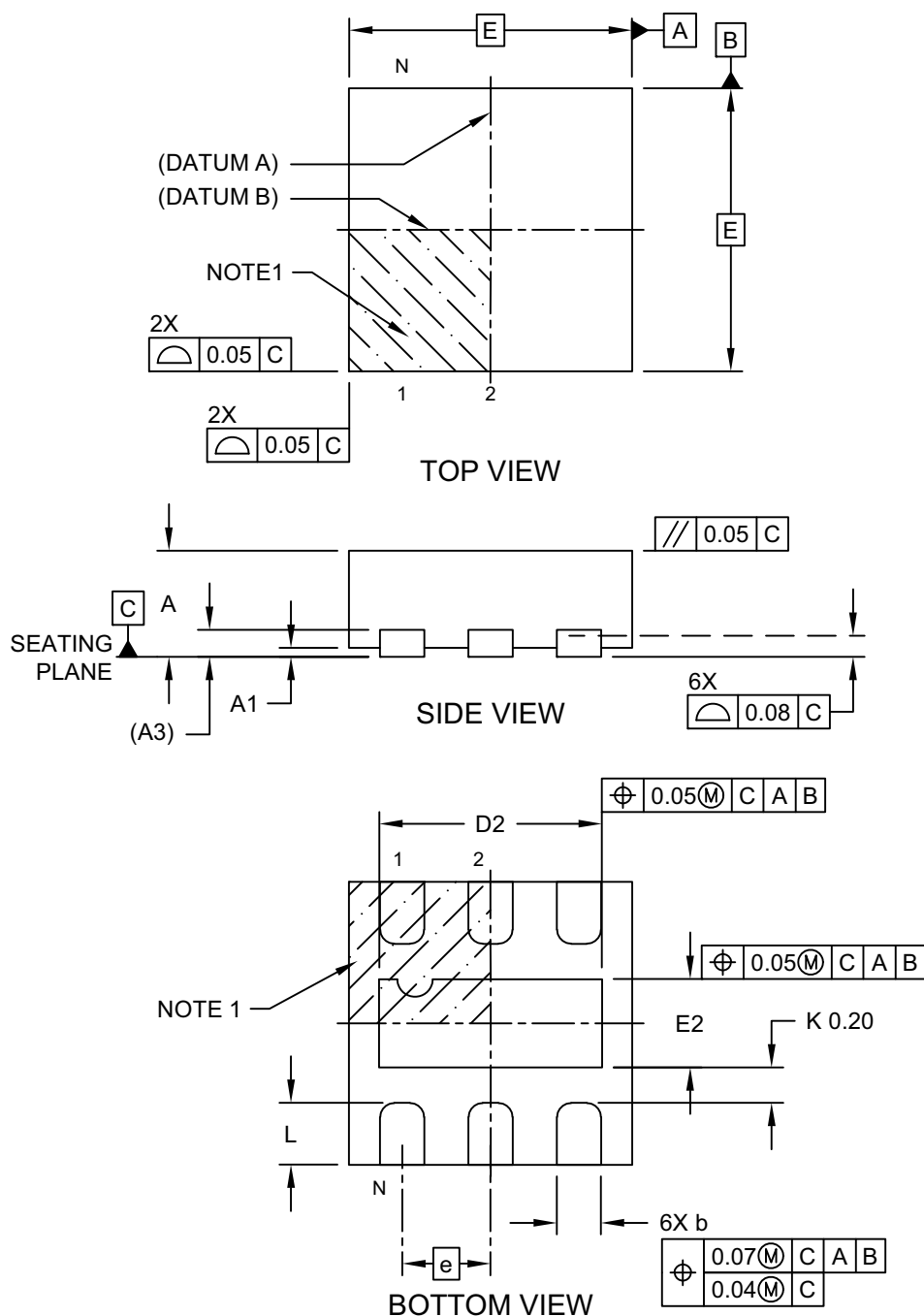
Note: If the full seven-character YYWWNNN code cannot fit on the package, the following truncated codes are used based on the available marking space: 6 Characters = YWWNNN; 5 Characters = WWNNN; 4 Characters = WNNN; 3 Characters = NNN; 2 Characters = NN; 1 Character = N.

TABLE 5-1: MARKING CODES

Part Number	Marking Code	Output Voltage	Auto-Discharge
MIC94325YMT	2R	Adjustable	No
MIC94345-FYMT	FL	1.5V	No
MIC94345-GYMT	1X	1.8V	No
MIC94345-MYMT	2X	2.8V	No
MIC94345-SYMT	3X	3.3V	No
MIC94355-FYMT	0G	1.5V	Yes
MIC94355-GYMT	2G	1.8V	Yes
MIC94355-MYMT	7G	2.8V	Yes
MIC94355-SYMT	8G	3.3V	Yes

6-Lead 1.6 mm x 1.6 mm UDFN [HKA] Package Outline & Recommended Land Pattern

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>

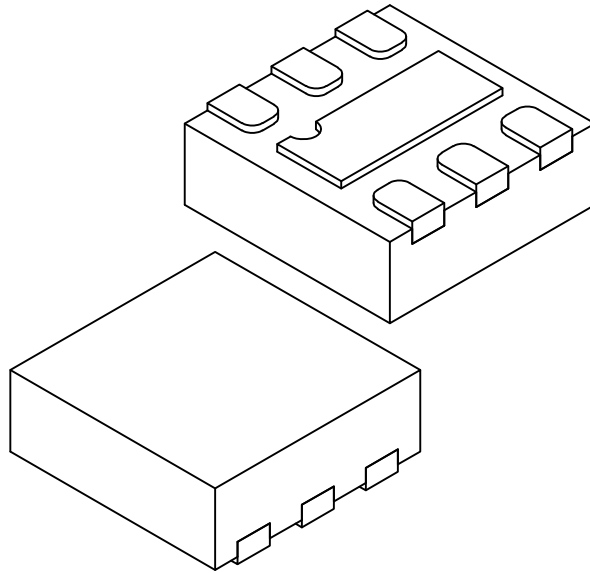


Microchip Technology Drawing C04-1154 Rev A Sheet 1 of 2

MIC94325/45/55

6-Lead 1.6 mm x 1.6 mm UDFN [HKA] Package Outline & Recommended Land Pattern

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Terminals	N	6		
Pitch	e	0.50 BSC		
Overall Height	A	0.50	0.55	0.60
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3	0.152 REF		
Overall Length	D	1.60 BSC		
Exposed Pad Length	D2	1.21	1.26	1.31
Overall Width	E	1.60 BSC		
Exposed Pad Width	E2	0.45	0.50	0.55
Terminal Width	b	0.20	0.25	0.30
Terminal Length	L	0.30	0.35	0.40
Terminal-to-Exposed-Pad	K	0.20	—	—

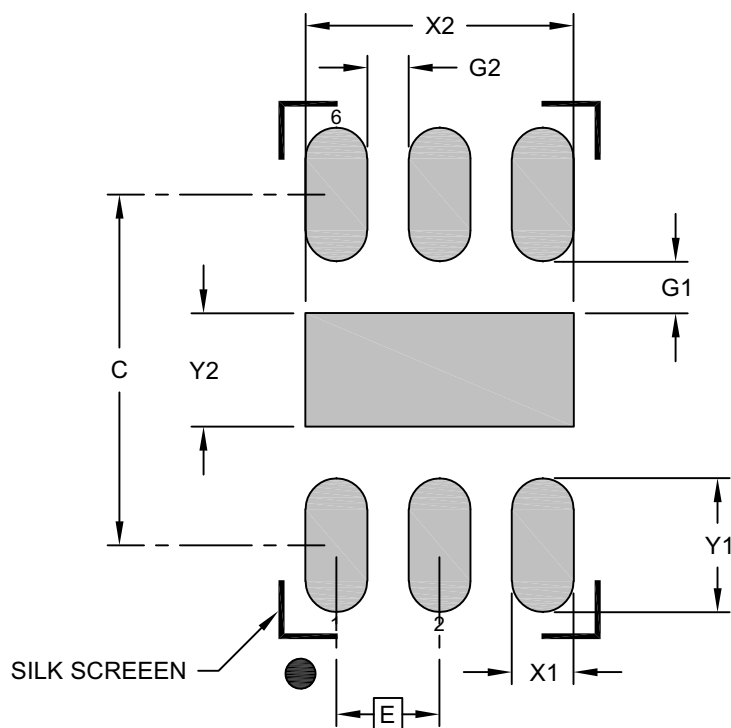
Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-1154 Rev A Sheet 2 of 2

6-Lead 1.6 mm x 1.6 mm UDFN [HKA] Package Outline & Recommended Land Pattern

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

		Units	MILLIMETERS		
Dimension Limits			MIN	NOM	MAX
Contact Pitch	E		0.50 BSC		
Center Pad Width	X2				1.30
Center Pad Length	Y2				0.55
Contact Pad Spacing	C			1.70	
Contact Pad Width (X6)	X1				0.30
Contact Pad Length (X6)	Y1				0.65
Contact Pad to Center Pad (X6)	G1		0.25		
Contact Pad to Contact Pad (X4)	G2		0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-3154 Rev A

APPENDIX A: REVISION HISTORY

Revision C (May 2026)

- Removed Obsolete devices from [Table 5-1](#).
- Updated [Product Identification System](#):
 - Added a list of Obsolete devices.
 - Removed the 1.2V Output Voltage option.

Revision B (July 2023)

- Changed all references to Thin DFN or TDFN throughout data sheet to Ultra Thin DFN or UDFN.
- Updated package outline drawings to correct UDFN PODs.
- Minor text and format changes throughout.

Revision A (March 2021)

- Converted Micrel document MIC94325/45/55 to Microchip data sheet template DS20006524A.
- Minor grammatical text changes throughout.
- Removed reference to the 6-Ball CSP package option.
- All schematic and BOM references removed as they are found in the User's Guide for these parts.

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

Device	-X	X	XX	-XX
Part No.	Output Voltage	Junction Temp. Range	Package	Media Type
Device:	MIC94325:	500 mA LDO with Ripple Blocker Technology and Adjustable Output Voltage		
	MIC94345:	500 mA LDO with Ripple Blocker Technology and Fixed Output Voltage		
	MIC94355:	500 mA LDO with Ripple Blocker Technology, Fixed Output Voltage, & Auto-Discharge		
Output Voltage:	<blank> = Adjustable (MIC94325 only)			
	F	=	1.5V	
	G	=	1.8V	
	M	=	2.8V	
	S	=	3.3V	
Junction Temperature Range:	Y	=	-40°C to +125°C	
Package:	MT	=	6-Lead 1.6 mm x 1.6 mm UDFN	
Media Type:	TR	=	5,000/Reel	
	T5	=	500/Reel	

Obsolete Devices:

MIC94345-4YMT-T5	MIC94355-4YMT-T5
MIC94345-4YMT-TR	MIC94355-4YMT-TR
MIC94345-MYMT-T5	MIC94355-MYMT-T5
MIC94345-MYMT-TR	MIC94355-MYMT-TR
MIC94345-FYMT-T5	
MIC94345-FYMT-TR	

Examples:

a) MIC94325YMT-TR: MIC94325, Adjustable Output Voltage, -40°C to +125°C Temperature Range, 6-Lead UDFN, 5,000/Reel

b) MIC94355-SYMT-TR: MIC94355, 3.3V Output Voltage, -40°C to +125°C Temperature Range, 6-Lead UDFN, 5,000/Reel

c) MIC94325YMT-T5: MIC94325, Adjustable Output Voltage, -0°C to +125°C Temperature Range, 6-Lead UDFN, 500/Reel

Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.

Microchip Information

Trademarks

The “Microchip” name and logo, the “M” logo, and other names, logos, and brands are registered and unregistered trademarks of Microchip Technology Incorporated or its affiliates and/or subsidiaries in the United States and/or other countries (“Microchip Trademarks”). Information regarding Microchip Trademarks can be found at <https://www.microchip.com/en-us/about/legal-information/microchip-trademarks>.

ISBN: 979-8-3371-3307-2

Legal Notice

This publication and the information herein may be used only with Microchip products, including to design, test, and integrate Microchip products with your application. Use of this information in any other manner violates these terms. Information regarding device applications is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. Contact your local Microchip sales office for additional support or, obtain additional support at www.microchip.com/en-us/support/design-help/client-support-services.

THIS INFORMATION IS PROVIDED BY MICROCHIP "AS IS". MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION INCLUDING BUT NOT LIMITED TO ANY IMPLIED WARRANTIES OF NON-INFRINGEMENT, MERCHANTABILITY, AND FITNESS FOR A PARTICULAR PURPOSE, OR WARRANTIES RELATED TO ITS CONDITION, QUALITY, OR PERFORMANCE.

IN NO EVENT WILL MICROCHIP BE LIABLE FOR ANY INDIRECT, SPECIAL, PUNITIVE, INCIDENTAL, OR CONSEQUENTIAL LOSS, DAMAGE, COST, OR EXPENSE OF ANY KIND WHATSOEVER RELATED TO THE INFORMATION OR ITS USE, HOWEVER CAUSED, EVEN IF MICROCHIP HAS BEEN ADVISED OF THE POSSIBILITY OR THE DAMAGES ARE FORESEEABLE. TO THE FULLEST EXTENT ALLOWED BY LAW, MICROCHIP'S TOTAL LIABILITY ON ALL CLAIMS IN ANY WAY RELATED TO THE INFORMATION OR ITS USE WILL NOT EXCEED THE AMOUNT OF FEES, IF ANY, THAT YOU HAVE PAID DIRECTLY TO MICROCHIP FOR THE INFORMATION.

Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Microchip Devices Code Protection Feature

Note the following details of the code protection feature on Microchip products:

- Microchip products meet the specifications contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is secure when used in the intended manner, within operating specifications, and under normal conditions.
- Microchip values and aggressively protects its intellectual property rights. Attempts to breach the code protection features of Microchip product is strictly prohibited and may violate the Digital Millennium Copyright Act.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of its code. Code protection does not mean that we are guaranteeing the product is “unbreakable”. Code protection is constantly evolving. Microchip is committed to continuously improving the code protection features of our products.